UNITED STATES SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

FORM 8-K

CURRENT REPORT

Pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): February 26, 2024 (February 25, 2024)

Odyssey Semiconductor Technologies, Inc. (Exact name of registrant as specified in its charter)

Delaware	333-234741	84-1766761				
(State or other jurisdiction of incorporation)	(Commission File Number)	(IRS Employer Identification No.)				
	9 Brown Road Ithaca, NY 14850 (Address of Principal Executive Offices)					
Regist	rant's telephone number including area code: (607) 351-976	8				
	N/A					
(Fo	ormer name or former address, if changed since last report)					
Check the appropriate box below if the Form 8-K filing is it	ntended to simultaneously satisfy the filing obligation of the	registrant under any of the following provisions:				
$\ \square$ Written communications pursuant to Rule 425 under the	ne Securities Act (17 CFR 230.425)					
$\ \square$ Soliciting material pursuant to Rule 14a-12 under the l	Exchange Act (17 CFR 240.14a-12)					
☐ Pre-commencement communications pursuant to Rule	14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))					
☐ Pre-commencement communications pursuant to Rule	13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))					
Indicate by check mark whether the registrant is an emergin of the Securities Exchange Act of 1934 (§ 240.12b–2 of thi	ng growth company as defined in Rule 405 of the Securities s chapter).	Act of 1933 (§ 230.405 of this chapter) or Rule 12b-2				
Emerging growth company \boxtimes						
If an emerging growth company, indicate by check mark if financial accounting standards provided pursuant to Section	the registrant has elected not to use the extended transition p $_1$ 13(a) of the Exchange Act. \square	period for complying with any new or revised				
Securities registered pursuant to Section 12(b) of the Act: N	None.					

Section 7 - Regulation FD

Item 7.01. Regulation FD Disclosure.

On February 26, 2024, Odyssey Semiconductor Technologies, Inc. (the "Company") published a press release to announce its financial results for the fourth quarter of 2023. The financial results have also been published on the website of the Company. The Company will not hold a conference call but will make Rick Brown, the CEO and cofounder, available for any questions from investors.

Copy of the press release is furnished hereto as Exhibit 99.1. The information contained in this Current Report on Form 8-K (including the exhibits) is being furnished and shall not be deemed "filed" for the purposes of Section 18 of the Securities Exchange Act of 1934, as amended (the "Exchange Act"), or otherwise subject to the liabilities of that Section, nor shall it be deemed incorporated by reference in any filing under the Securities Act of 1933, as amended, or the Exchange Act, except as otherwise expressly stated in such filing.

Section 9 - Financial Statements and Exhibits

Item 9.01. Financial Statements and Exhibits.

(c) Exhibits

Exhibit No. Description

99.1 Press Release of Odyssey Semiconductor Technologies, Inc., dated February 26, 2024
104 Cover Page Interactive Data File (embedded within the Inline XBRL document)

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

Odyssey Semiconductor Technologies, Inc.

February 26, 2024 By: /s/ Rick Brown

Name: Rick Brown

Title: Chief Executive Officer



Odyssey Semiconductor Technologies Reports Fourth Quarter and Full Year 2023 Financial Results

February 26, 2024 5:10 PM EST

Company continues to develop and look for financing and strategic opportunities

ITHACA, NY / ACCESSWIRE / February 26, 2024 / Odyssey Semiconductor Technologies, Inc. (OTCQB:ODII), a semiconductor device company developing innovative high-voltage power switching components based on proprietary Gallium Nitride ("GaN") processing technology, today reported its fourth quarter and full year 2023 results.

CEO Commentary

"We have continued to work on scaling our Vertical GaN technology and developing the manufacturing process to build a larger device that can handle higher current (power is equal to current times voltage). This larger device will enable us to more widely sample to customers. With industry-leading innovation, Odyssey's approach to vertical GaN will offer even greater commercial advantages over silicon, silicon carbide or lateral GaN," said Rick Brown, Chief Executive Officer.

"We are also making progress with foundry services projects. With initial work being completed and providing revenue in Q4 we have booked and are working on additional business for Q1 and Q2. This has also led to some rebalancing of resource deployment between internal product development and externally focused foundry service projects. We are also continuing to review strategic opportunities to address longer term financing needs," continued Brown.

We are continuing to take product sample requests. Customers can request information and samples of the 650 and 1200 volt vertical GaN power devices at info@odysseysemi.com.

Significant Recent Advancements and Milestones

Odyssey Uniquely Positioned in High Growth Megatrend Movement to High Voltage in 2027 in Odyssey's Addressable Market

Odyssey's approach to vertical GaN will offer even greater commercial advantages over silicon than silicon carbide or lateral GaN. Vertical GaN offers a 10x advantage over silicon carbide (SiC) at performance and cost levels unattainable by the competing technologies.

The market the Company is pursuing is large and fast-growing. The 650-volt segment is the larger market today, expected to continue to grow. The 1200-volt product market segment is expected to grow faster and will become the larger market in the second half of this decade. Together, the 650 and 1200-volt power device market is expected to exceed \$5 billion in 2027, a 40% combined CAGR according to Yole Group, a French market research firm.

Other Corporate Actions:

The Chairman of the Board, Mr. Edmunds, has continued to finance the company's operations through monthly promissory notes - one in January and one in February - each for \$ 190,000. Mr. Edmunds will likely not continue to fund the Company's operations in the future and the Company is reviewing options to continue development of its technology. The Board has recently engaged in various strategic discussions with third parties and it has become apparent that the "know how developed by the two founders" is one of the company's most valuable assets. The Board discussed incentives that might be provided to ensure the two founders stay with the company and entertain the possibility of potentially working for one of the interested parties in the future as part of a strategic transaction. With sensitivity to both the amount of debt outstanding and to avoid dilution, Mr. Edmunds offered and the Board has approved, to have approximately 14.5% of his outstanding debt previously issued to fund operations or approximately \$632,800 in principal value cancelled and reissued under the same terms and maturity to be split evenly in favor of each of the two founders. This will give them both a debt and equity interest in the outcome of any strategic deal similar to Mr. Edmunds. In addition, Mr. Edmunds has elected to convert one of his \$ 180,000 promissory notes to stock at \$0.10 per share resulting in an additional 1.8M Common shares being issued. This will increase his shareholdings to approximately 13.4%.

Conference Call and Webcast: Q4 and Full Year 2023 Results

The Company will not be holding a conference call - investors may contact Rick Brown, the CEO and co-founder, if they have questions.

About Odyssey Semiconductor Technologies, Inc.

Odyssey Semiconductor Technologies, Inc., has developed a proprietary technology that is designed to allow for GaN to replace SiC as the emerging high-voltage power-switching semiconductor material. Based in Ithaca, NY, the Company owns and operates a 10,000 sq. ft. semiconductor wafer manufacturing facility complete with a mix of class 1,000 and class 10,000 clean space as well as tools for advanced semiconductor development and production. Odyssey Semiconductor also offers a world-class semiconductor device development and foundry service.

For more information, visit the Company's website at www.odysseysemi.com and LinkedIn.

Forward-Looking Statements

Statements in this press release that are not descriptions of historical facts are forward-looking statements within the meaning of the safe harbor provisions of the Private Securities Litigation Reform Act of 1995. These forward-looking statements include, but are not limited to, statements about our plans, objectives, forecasts, representations and contentions and are not historical facts and typically are identified by use of terms such as "may," "will," "should," "could," "expect," "plan," "forecast", "anticipate," "believe," "estimate," "predict," "potential," "continue" and similar words, although some forward-looking statements are expressed differently. These forward-looking statements are based on management's current expectations and assumptions and are subject to risks and uncertainties described more fully in the company's filings on Forms 10-K and 10-Q and other periodic filings with the Securities and Exchange Commission. Factors that could cause actual results to differ materially from those currently anticipated include, without limitation, risks relating to the results of our research and development activities, including uncertainties relating to semiconductor process manufacturing; the early stage of our GaN-based technology presently under development; our ability to protect our intellectual property rights that are valuable to our business, including patent and other intellectual property rights; our ability to successfully market and sell our technologies; the ability to achieve high volume manufacturing and the size and growth of the potential markets for any of our technologies, the rate and degree of market acceptance of any of our technologies and our ability to raise funding to support operations and the continued development and qualification of our technology.

In light of these risks, uncertainties and assumptions, the forward-looking statements regarding future events and circumstances discussed in this press release may not occur, and actual results could differ materially and adversely from those anticipated or implied in the forward-looking statements. You should not rely upon forward-looking statements as predictions of future events. The forward-looking statements included herein speak only as of the date hereof, and we undertake no obligation to update publicly or privately any forward-looking statements for any reason after the date of this release to conform these statements to actual results or to changes in our expectations.

Contact

Rick Brown, CEO rbrown@odysseysemi.com 607-351-9768

Consolidated Financial Results

All financials referenced in this release are unaudited and intended to conform with U.S. Generally Accepted Accounting Principles ("GAAP") and comparisons in this release are to the same period in the prior year unless otherwise noted.

ODYSSEY SEMICONDUCTOR TECHNOLOGIES, INC. AND SUBSIDIARIES CONDENSED CONSOLIDATED BALANCE SHEETS (Unaudited)

		cember 31,	December 31, 2022		
		3(unaudited)			
Assets					
Current Assets:					
Cash	\$	47,388	\$	2,428,289	
Accounts receivable		25,000		50,750	
Prepaid expenses and other current assets		81,334		68,204	
Total Current Assets		153,722		2,547,243	
Restricted cash		103,273		103,240	
Property and equipment, net		807,133		989,246	
		362,366		532,953	
Operating ROU Asset		302,300		332,933	
Total Assets	\$	1,426,494	\$	4,172,682	
Total Assets	Ф	1,420,494	Ф	4,172,082	
Liabilities and Stockholders' Equity					
Current Liabilities:	Ф	501.605	Ф	202.005	
Accounts payable and accrued expenses	\$	581,607	\$	382,905	
Loan payable - short term		72,142		72,424	
Lease Liability - short term	_	196,316		172,496	
Total Current Liabilities		507,312		507,312	
Long-term lease liability		232,714		361.457	
Convertible Bridge Loan		5,066,000		4,442,000	
Accrued Interest Bridge Loan		419,126		51,983	
Loans payable - long term		184,419		264,729	
Total liabilities		6,757,324		5,746,994	
Commitments and contingencies		0,737,324		5,740,774	
Communicates and contingencies					
Stockholders' Equity:					
Preferred stock, \$0.0001 par value, 5,000,000 shares authorized; 0 shares issued and outstanding as of December 31, 2023 and December 31, 2022		_			
Common stock, \$0.0001 par value, 45,000,000 shares authorized, 12,726,911 shares issued and outstanding as of					
December 31, 2023 and December 31, 2022		1,272		1,272	
Additional paid-in capital		11.492.244		10.800.268	
Accumulated deficit		(16,824,346)		(11,533,852)	
1.000		(,,-10)		(,,002)	
Total Stockholders' Equity		(5,330,830)		(732,312)	
Total Liabilities and Stockholders' Equity	\$	1,426,494	\$	4,172,682	
Total Datomices and Stockholders Equity	Ψ	1,120,174	Ψ	1,172,002	

ODYSSEY SEMICONDUCTOR TECHNOLOGIES, INC. AND SUBSIDIARIES CONDENSED CONSOLIDATED STATEMENTS OF OPERATIONS (Unaudited)

	For The Three Months Ended December 31, 2023 2022			For The Twelve months ended December 31, 2023 2022				
Revenues	\$	90,000	\$	208,780	\$	291,900	\$	321,049
Cost of Revenues		81,963		129,111		204,826		228,449
Gross Profit (Loss)		8,037		79,669		87,074		92,550
Operating Expenses:								
Research and development		453,482		535,123		1,989,664		2,085,815
Write off of fixed asset deposit		-		153,126				153,126
Selling, general, and administrative		266,376		653,308		1,995,792		2,964,610
Total Operating Expenses		719,858		1,341,557	_	3,985,456	_	4,933,551
Loss From Operations		(711,821)		(1,261,888)	_	(3,898,382)	_	(4,841,001)
Other Income (Expense):								
Forgiveness of PPP loan and other income		7		3,520		40,293		26,798
Interest expense		(101,155)		(33,107)		(380,492)		(61,496)
Change in Fair Value of Contingent Liability				(842,000)		(234,000)		(842,000)
Net Loss	\$	(812,969)	\$	(2,133,475)	\$	(4,472,581)	\$	(5,693,612)
Net (Loss) Income Per Share:								
Diluted	\$	(0.06)	\$	(0.17)	\$	(0.35)	\$	(0.45)
Weighted Average Number of Common Shares Outstanding:								
Diluted		12,726,911		12,419,399		12,726,911		12,726,911

ODYSSEY SEMICONDUCTOR TECHNOLOGIES, INC. AND SUBSIDIARIES CONDENSED CONSOLIDATED STATEMENTS OF CASH FLOWS (Unaudited)

For The Twelve Months Ended December 31 2023 2022 **Cash Flows From Operating Activities:** Net loss \$ (4,875,699) \$ (5,693,612)Adjustments to reconcile net loss to net cash used in operating activities: Stock-based compensation 926,923 902,836 Fair value adjustment of notes 234,000 842,000 153,126 Fixed asset deposit - Reserve Accrued Interest 367,143 132,211 Depreciation and amortization 191,902 Changes in operating assets and liabilities: Contract assets Accounts receivable 25,750 (44,580)Prepaid expenses and other current assets (13,130)3,930 Deferred expenses 7,870 Accounts payable and accrued expenses 341,245 286,941 Deferred revenue (10,000)Total Adjustments 1,787,094 2,274,334 **Net Cash Used In Operating Activities** (2,685,487)(3,419,278)Cash Flows Used In Investing Activities: Purchases of property and equipment (9,789)(268,167)(9,789)(268,167)Net Cash Used In Investing Activities **Cash Flows From Financing Activities:** 390,000 3,600,000 Proceeds from Convertible Bridge Loan (75,592)(82,440) Repayment of government loans Net Cash Provided By (Used In) Financing Activities 314,408 3,517,560 Net Increase (Decrease) In Cash and Restricted Cash (2,380,868)(169,885)2,531,529 2,701,414 Cash and Restricted Cash - Beginning Of Period Cash and Restricted Cash - End Of Period 150,661 2,531,529 Cash and Restricted Cash Consisted of the Following: \$ 47,388 \$ 2,428,289 Cash 103,201 Restricted cash 103,240 150,661 2,531,529 Supplemental Disclosures of Cash Flow Information: Cash paid during the year for:

See notes to these condensed consolidated financial statements.

Interest Income taxes